

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Reinhard Loewe	03/21/2011
Per Krueger	03/21/2011
Michael Knebel	03/22/2011
Jens Ehreke	03/21/2011
Heinz Pudleiner	02/28/2011
Mehmet-Cengiz Yesildag	03/07/2011
Klaus Meyer	03/02/2011
Dirk Pophusen	03/02/2011
Joerg Buechner	03/08/2011

RECEIVING PARTY DATA

Name:	Bayer MaterialScience AG
Street Address:	Patents & Licensing
Internal Address:	Building Q 18
City:	Leverkusen
State/Country:	GERMANY
Postal Code:	D-67056

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13125077

CORRESPONDENCE DATA

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**PATENT
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Address Line 4: Wilmington, DELAWARE 19801

ATTORNEY DOCKET NUMBER:

15778-00391-US

NAME OF SUBMITTER:

David M. Morse

Total Attachments: 1
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Assignment

For valuable consideration, the receipt and adequacy of which is hereby acknowledged,

I/We

1. Dr. Reinhard LÖWE, Bundschuchstrasse 12, 14542 Werder OT Phöben, DE
2. Dr. Per KRÜGER, Markobrunner Str. 23, 14197 Berlin, DE
3. Michael KNEBEL, Marienburger Str. 7, 10405 Berlin, DE
4. Jens EHREKE, Peter-Hille-Strasse 107, 12587 Berlin
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6. Mehmet-Cengiz YESILDAG, Friedrichstr. 8a, 51377 Leverkusen, DE
7. Klaus MEYER, Kamillenstr. 40, 41539 Dormagen, DE
8. Dirk POPHUSEN, Im Neuen Feld 81, 51467 Bergisch Gladbach, DE
9. Jörg BÜCHNER, Im Plackenbruch 41, 51467 Bergisch Gladbach, DE

hereby sell, assign, and transfer unto BAYER MATERIALSCIENCE AG a corporation of DE, located at 51368 LEVERKUSEN, DE the entire right, title, and interest in and to my/our application for Letters Patent of the United States, executed concurrently herewith, entitled

LATENT-REACTIVELY GLUED TPU/PC LAYER MATERIALS

Filed: 2009-07-20 PCT-Serial No.: PCT/DE2009/000996

and my/our entire right, title, and interest in and to all my/our inventions, whether joint or sole, disclosed in said application or Letters Patent, and in and to all divisional or continuation applications that may be filed for United States Letters Patent for any of said inventions, and in and to all patents that may be granted on the foregoing applications, and I/we hereby agree, whenever requested, to communicate to said assignee, its successors and assigns, any facts known to me/us respecting said inventions and to execute all applications or papers necessary to obtain and maintain proper patent protection on said inventions in the United States.

Date/Datum:

Inventor(s)/Erfinder:

- 2011-03-20
- 2011-03-21
- 2011-03-22
- 2011-03-21
- 2011-02-28
- 2011-03-07
- 2011-03-02
- 2011-03-02
- 2011-03-08

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7. Klaus Meyer
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